

PATENT NUMBER and
ISSUE DATE

U.S. UTILITY Patent Application

APPL NUM 10081979	FILING DATE 02/22/2002	CLASS 435	SUBCLASS - 7 -	GAU 1653	EXAMINER Marcheschi
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**APPLICANTS: Singh Rajiv; Lee Seung-Mahn;

**CONTINUING DATA VERIFIED:

** FOREIGN APPLICATIONS VERIFIED:

PG-PUB	DO NOT PUBLISH <input type="checkbox"/>	RESCIND <input type="checkbox"/>	
Foreign priority claimed 35 USC 119 conditions met Verified and Acknowledged Examiner's initials		<input type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> yes <input type="checkbox"/> no	ATTORNEY DOCKET NO 5853-223
TITLE : Chemical-mechanical polishing slurry for polishing of copper or silver films U.S. DEPT. OF COMM./PAT. & TM-PTO-436L(Rev. 12-94)			

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
		Assistant Examiner	
ISSUE FEE		Primary Examiner	
Amount Due	Date Paid	Total Claims	Print Claim for O.G.
TERMINAL DISCLAIMER		DRAWING	
		Sheets Drwg.	Figs.Drwg.
		Print Fig.	
		Application Examiner	
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